

<b>Notice of References Cited</b>			Application/Control No. 09/777,435	Applicant(s)/Patent Under Reexamination SINGH ET AL.
Examiner Elias Desta			Art Unit 2857	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	C	US-6,332,110	12-2001	Wolfe, Thomas D.	702/22
	D	US-6,052,653	04-2000	Mazur et al.	702/57
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**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Pierce, 'Golden Nuggets of AMHS Modeling and Design for Semiconductor Wafer Fabrication', January 1994, IEEE, pages 200-204
	V	SANDIA NATIONAL LABORATORIES, 'BMP, Best Manufacturing Practices', May 1995, College Park Maryland, pages 1-58
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.